2198373-1 ACTIVE

zQSFP+/QSFP28

TE Internal #: 2198373-1

zQSFP+, Cage Assembly with Integrated Connector, .8mm [.032in]

Centerline, Sealable, Signal, Operating Temperature Range -40 –

85 °C [-40 – 185 °F]

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Connectors > Pluggable IO Connectors & Cages



Pluggable I/O Product Type: Cage Assembly with Integrated Connector

Centerline (Pitch): .8 mm [.032 in]

Sealable: Yes

Circuit Application: Signal

Operating Temperature Range: -40 - 85 °C [-40 - 185 °F]

Features

Product Type Features

Product Type Features	
Cage Type	Stacked
Pluggable I/O Product Type	Cage Assembly with Integrated Connector
Sealable	Yes
Form Factor	zQSFP+
Configuration Features	
Number of Rear EONs per Port Column	3
Number of Positions	76
Number of Ports	2
Port Matrix Configuration	2 x 1
Electrical Characteristics	
Data Rate (Max)	28 Gb/s

Contact Features

Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Underplating Material	Tin
PCB Contact Termination Area Plating Material	Gold
Contact Current Rating (Max)	.5 A



Termination Features

Termination Post & Tail Length	2 mm[.079 in]
Termination Method to PCB	Through Hole - Press-Fit
Housing Features	
Cage Material	Nickel Silver
Centerline (Pitch)	.8 mm[.032 in]
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]
Operation/Application	
Pluggable I/O Applications	SFP+ Stacked Belly-to-Belly
Heat Sink Compatible	No
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tray
Other	
Included Lightpipe	No
EMI Containment Feature Type	Elastomeric Gasket

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC



Free

Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | zQSFP+/QSFP28







Customers Also Bought

























Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2198373-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2198373-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2198373-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

QSFP28/56 and zQSFP+ Interconnects

English

Product Specifications

Application Specification

English